



I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: January 15, 2003 Signature: \_\_\_\_\_

(Kimberly V. Perry)

**JAN 30 2003**

Docket No.: TESSERA 3.3-018 CONT II CON  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Letters Patent of:

*Khandros et al*

Patent No.: 6,465,893

Issued: October 15, 2002

For: STACKED CHIP ASSEMBLY

Certificate of Correction Branch  
Commissioner for Patents  
Washington, DC 20231

**Certificate**

**JAN 29 2003**

**of Correction**

**REQUEST FOR CERTIFICATE OF CORRECTION PURSUANT TO 37 CFR 1.323**

Dear Sir:

Enclosed herewith is an original and one copy of a Certificate of Correction with respect to the above-identified U.S. Patent. You are hereby authorized to charge Deposit Account No. 12-1095 in the amount of \$100 to cover the required fee for filing a Certificate of Correction under § 1.323.

These errors were inadvertent, occurred in good faith and do not involve any changes which constitute new matter.

We look forward to early return of the copy of the Certificate of Correction duly certified.

Dated: January 15, 2003

Respectfully submitted,

By \_\_\_\_\_

Kimberly V. Perry

Registration No.: 43,612

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01/23/2003 MAHMED2 00000103 121095 6465893

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(Also Form PTO-1050)

## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO. : 6,465,893 <sup>B1</sup>  
DATED : October 15, 2002  
INVENTOR(S) : Igor Y. Khandros and Thomas H. DiStefano

It is certified that error appears in the above-identified patent and that said Letters  
Patent is hereby corrected as shown below:

*T. Hepg Item [57]*

~~Cover page~~, (57), line 1, "chip assembly," should read --chip assembly--  
Column 7, line 6, "overly" should read --overlie--  
Column 11, line 45, "curved" should read --be curved--  
Column 15, line 53, "method to according" should read --method according--  
Column 15, line 56, "bonding 5 separately" should read --bonding separately--  
Column 16, line 8, "encapsulant which may" should read --encapsulant may--  
Column 18, line 3, "constitute a" should read --constitute an--  
Column 26, line 20, "also band" should read --also bend--  
Column 30, line 60, "as a."I/O count" should read --as an "I/O count,"  
Column 34, line 50, "contact" should read --contacts--  
Column 35, line 54, "terminals disposed" should read --terminals are disposed--  
Column 35, line 62, "claimed any" should read --claimed in any--  
Column 36, line 65, "wherein central" should read --wherein a central--  
Column 39, line 42, "contact" should read --contacts--

MAILING ADDRESS OF SENDER:

Kimberly V. Perry

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Westfield, New Jersey 07090

PATENT NO.: 6,465,893

No. of additional copies:

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Column 26, line 20, "also band" should read --also bend--  
Column 30, line 60, "as a "I/O count" should read --as an "I/O count,"  
Column 34, line 50, "contact" should read --contacts--  
Column 35, line 54, "terminals disposed" should read --terminals are disposed--  
Column 35, line 62, "claimed any" should read --claimed in any--  
Column 36, line 65, "wherein central" should read --wherein a central--  
Column 39, line 42, "contact" should read --contacts--

MAILING ADDRESS OF SENDER:

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Lerner, David, Littenberg, Krumholz & Mentlik, LLP

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Westfield, New Jersey 07090

PATENT NO.: 6,465,893

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UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,465,893 B1  
DATED : October 15, 2002  
INVENTOR(S) : Igor Y. Khandros and Thomas H. DiStefano

Page 1 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page.

Item [57], **ABSTRACT**,

Line 1, "chip assembly," should read -- chip assembly --

Column 7.

Line 6, "overly" should read -- overlie --

Column 11.

Line 45, "curved" should read -- be curved --

Column 15.

Line 53, "method to according" should read -- method according --

Line 56, "bonding 5 separately" should read -- bonding separately --

Column 16.

Line 8, "encapsulant which may" should read -- encapsulant may --

Column 18.

Line 3, "constitute a" should read -- constitute an --

Column 26.

Line 20, "also band" should read -- also bend --

Column 30.

Line 60, "as a "I/O count" should read -- as an "I/O count --

Column 34.

Line 50, "contact" should read -- contacts --

Column 35.

Line 54, "terminals disposed" should read -- terminals are disposed --

Column 35.

Line 62, "claimed any" should read -- claimed in any --

Column 36.

Line 65, "wherein central" should read -- wherein a central --

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,465,893 B1  
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Page 2 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 39,

Line 42, "contact" should read -- contacts --

Signed and Sealed this

Eleventh Day of March, 2003

A handwritten signature in black ink, appearing to read "James E. Rogan", with a horizontal line drawn underneath it.

JAMES E. ROGAN  
*Director of the United States Patent and Trademark Office*